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April 2000

## FQP7N20

### 200V N-Channel MOSFET

### **General Description**

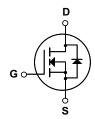
These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switching DC/DC converters, switch mode power supply, DC-AC converters for uninterrupted power supply, motor control.

### **Features**

- 6.6A, 200V,  $R_{DS(on)}$  = 0.69 $\Omega$  @V<sub>GS</sub> = 10 V Low gate charge ( typical 8.0 nC)
- Low Crss (typical 9.0 pF)
- · Fast switching
- 100% avalanche tested
- · Improved dv/dt capability





## **Absolute Maximum Ratings** T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter		FQP7N20	Units	
V <sub>DSS</sub>	Drain-Source Voltage		200	V	
I <sub>D</sub>	Drain Current - Continuous (T <sub>C</sub> = 25°C)		6.6	Α	
	- Continuous (T <sub>C</sub> = 100°C)		4.2	Α	
I <sub>DM</sub>	Drain Current - Pulsed	(Note 1)	26	Α	
V <sub>GSS</sub>	Gate-Source Voltage		± 30	V	
E <sub>AS</sub>	Single Pulsed Avalanche Energy	(Note 2)	73	mJ	
I <sub>AR</sub>	Avalanche Current	(Note 1)	6.6	А	
E <sub>AR</sub>	Repetitive Avalanche Energy	(Note 1)	6.3	mJ	
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	5.5	V/ns	
$P_D$	Power Dissipation (T <sub>C</sub> = 25°C)		63	W	
	- Derate above 25°C		0.51	W/°C	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +150	°C	
T <sub>L</sub>	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C	
			330		

### **Thermal Characteristics**

Symbol	Parameter	Тур	Max	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case		1.98	°C/W
$R_{\theta CS}$	Thermal Resistance, Case-to-Sink	0.5		°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient		62.5	°C/W

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Cha	aracteristics					
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA	200			V
ΔBV <sub>DSS</sub> / ΔT <sub>J</sub>	Breakdown Voltage Temperature Coefficient	I <sub>D</sub> = 250 μA, Referenced to 25°C	;	0.27		V/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 200 V, V <sub>GS</sub> = 0 V			1	μΑ
		V <sub>DS</sub> = 160 V, T <sub>C</sub> = 125°C			10	μA
I <sub>GSSF</sub>	Gate-Body Leakage Current, Forward	V <sub>GS</sub> = 30 V, V <sub>DS</sub> = 0 V			100	nA
I <sub>GSSR</sub>	Gate-Body Leakage Current, Reverse	V <sub>GS</sub> = -30 V, V <sub>DS</sub> = 0 V			-100	nA
On Cha	aracteristics					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$	3.0		5.0	V
R <sub>DS(on)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 3.3 A		0.55	0.69	Ω
9 <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 40 V, I <sub>D</sub> = 3.3 A (Note 4		4.0		S
C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub>	Input Capacitance Output Capacitance Reverse Transfer Capacitance	V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V, f = 1.0 MHz		300 60 9	400 75 12	pF pF pF
	ing Characteristics				1	
t <sub>d(on)</sub>	Turn-On Delay Time			8	25	ns
t <sub>r</sub>	Turn-On Rise Time	$V_{DD} = 100 \text{ V}, I_D = 6.6 \text{ A},$ $R_G = 25 \Omega$		65	140	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	NG - 23 22		15	40	ns
t <sub>f</sub>	Turn-Off Fall Time	(Note 4, 5	5)	35	80	ns
Qg	Total Gate Charge	V <sub>DS</sub> = 160 V, I <sub>D</sub> = 6.6 A, V <sub>GS</sub> = 10 V		8.0	10	nC
Q <sub>gs</sub>	Gate-Source Charge			2.4		nC
Q <sub>gd</sub>	Gate-Drain Charge	(Note 4, 5	5)	3.3		nC
	Source Diode Characteristics a	nd Maximum Ratings				
I <sub>S</sub>	Maximum Continuous Drain-Source Diode Forward Current				6.6	Α
I <sub>SM</sub>	Maximum Pulsed Drain-Source Diode Forward Current				26	Α
$V_{SD}$	Drain-Source Diode Forward Voltage	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 6.6 A			1.5	V
t <sub>rr</sub>	Reverse Recovery Time	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 6.6 A,		115		ns
Q <sub>rr</sub>	Reverse Recovery Charge	dI <sub>F</sub> / dt = 100 A/μs (Note 4)		0.51	1	μС

- **Notes:**1. Repetitive Rating : Pulse width limited by maximum junction temperature 2. L = 2.5mH, I<sub>AS</sub> = 6.6A, V<sub>DD</sub> = 50V, R<sub>G</sub> = 25  $\Omega$ , Starting T<sub>J</sub> = 25°C 3. I<sub>SD</sub>  $\leq$  6.6A, di/dt  $\leq$  300A/μs, V<sub>DD</sub>  $\leq$  BV<sub>DSS</sub>, Starting T<sub>J</sub> = 25°C 4. Pulse Test : Pulse width  $\leq$  300 $\mu$ s, Duty cycle  $\leq$  2% 5. Essentially independent of operating temperature

## **Typical Characteristics**

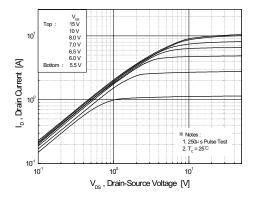


Figure 1. On-Region Characteristics

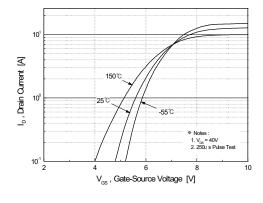


Figure 2. Transfer Characteristics

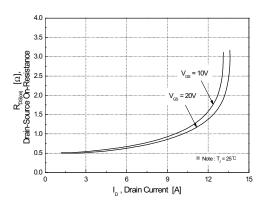


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

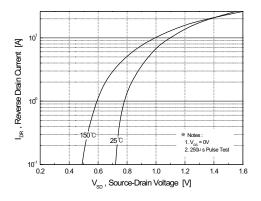


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

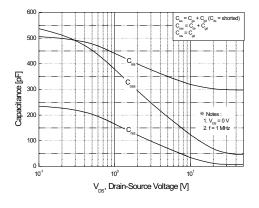


Figure 5. Capacitance Characteristics

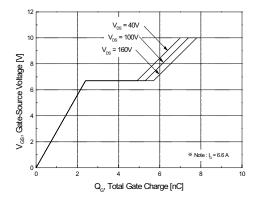


Figure 6. Gate Charge Characteristics

## Typical Characteristics (Continued)

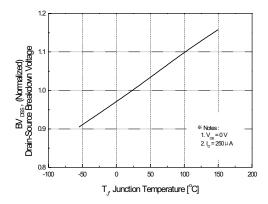


Figure 7. Breakdown Voltage Variation vs. Temperature

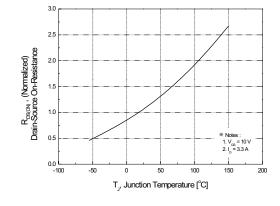


Figure 8. On-Resistance Variation vs. Temperature

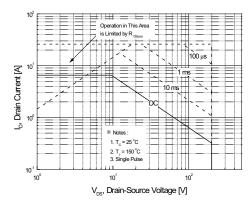


Figure 9. Maximum Safe Operating Area

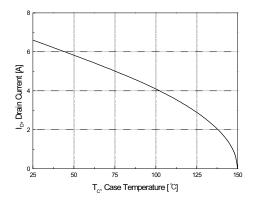


Figure 10. Maximum Drain Current vs. Case Temperature

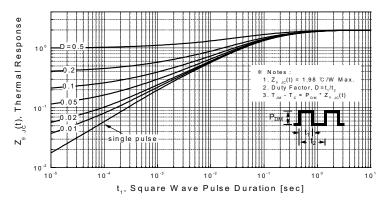
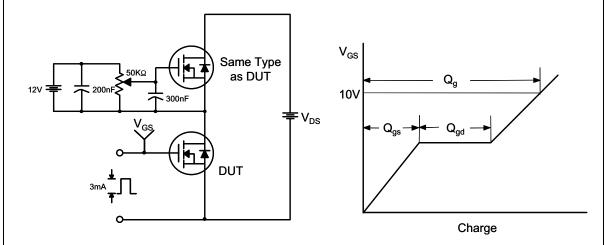


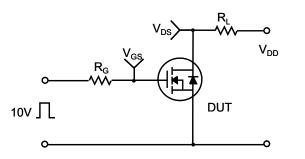
Figure 11. Transient Thermal Response Curve

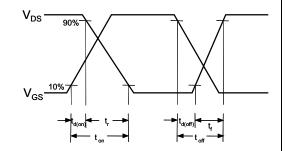
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### **Gate Charge Test Circuit & Waveform**

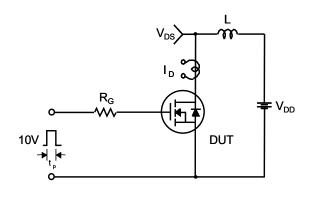


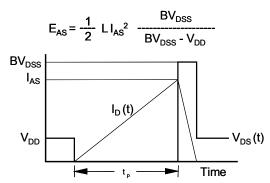
### **Resistive Switching Test Circuit & Waveforms**



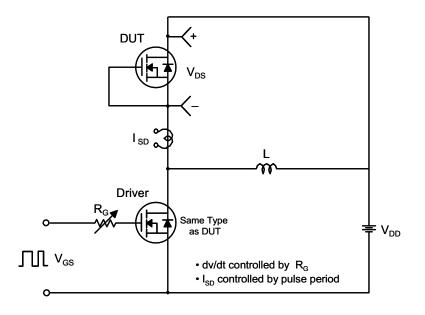


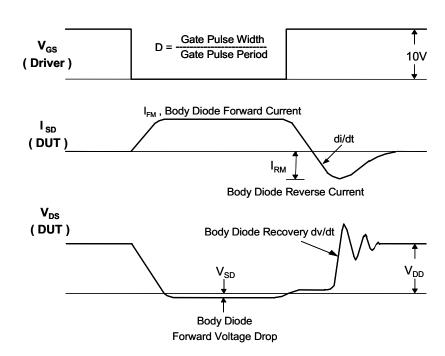
### **Unclamped Inductive Switching Test Circuit & Waveforms**

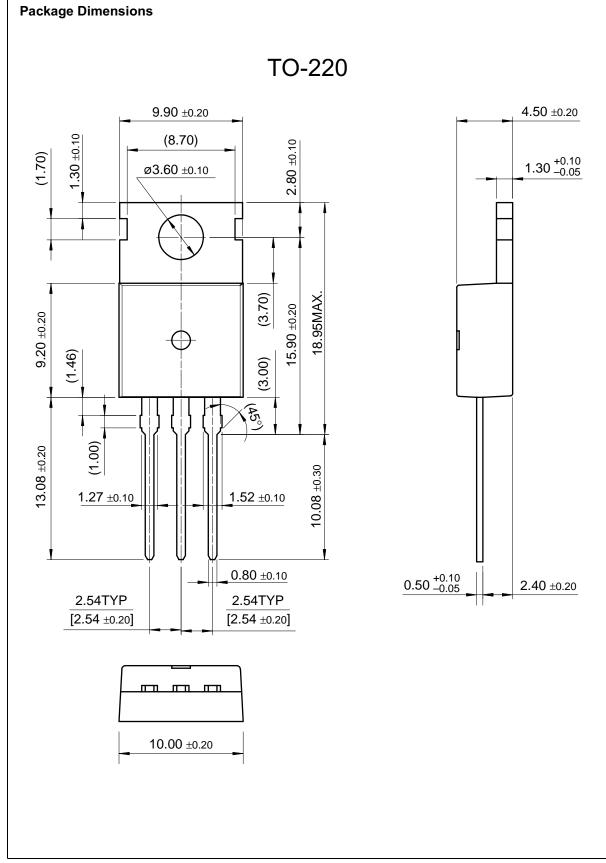




### Peak Diode Recovery dv/dt Test Circuit & Waveforms







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